A∠IENWARE® M17x COMPREHENSIVE SPECIFICATIONS

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COMPREHENSIVE SPECIFICATIONS

Processor and System Chipset		Computer Model		
s of DDR3 memory up	one or two 64-bit channels to 1333 MHz	SDRAM bus width		Alienware M17x-R2
	32 bits	Processor address bus		Dimensions
		width	51.31 mm to 53.59 mm (2.02 inches to 2.11 inches)	Height
	64 bits	Processor data width		(Front to Back)
	16 Mbit	BIOS EPROM	405.89 mm (15.98 inches)	Width
16 PCIe MXM 3.0	PCle x16 bus supporting x10	Graphics bus	321.31 mm (12.65 inches)	Depth
	graphics cards	·	5.3 kg (11.8 lb)	Weight with 9-cell battery
	32 bits	PCI bus	NOTE: The weight of your lanton will vary	(starting at)
		Memory	depending on the configuration ordered and the manufacturing variability.	
SODIMM sockets	two internally-accessible S	Connectors	,	
odules	2 GB and 4 GB memory mo	Capacities	Processor and System Chipset	
	DDR3 1067 MHz, 1333 MHz (dual-channel configuratio	Memory types	Intel® Core™ i7 Intel Core i5	Processor
omary is supported only	NOTE: DDD2 1222 MHz ma		256 KB	L2 cache
	on computers with an Inte		up to 8 MB	L3 cache
	4 GB, 6 GB, and 8 GB	Memory configurations	133 MHz	
		possible	Mobile Intel PM55	System chipset
odules z ons) emory is si	2 GB and 4 GB memory mo DDR3 1067 MHz, 1333 MHz (dual-channel configuratio NOTE : DDR3 1333 MHz me on computers with an Inte	Connectors Capacities Memory types Memory configurations	manufacturing variability. Diset Intel® Core™ i7 Intel Core i5 256 KB up to 8 MB 133 MHz	Processor L2 cache L3 cache Bus clock

ExpressCard		Ports and Connectors		
Interface supports PCle and USB 2.0 Connector one 26-pin ExpressCard slot (54 mm)		Audio	one microphone connector, three stereo headphone/speaker connectors	
	ExpressCard/34 (34 mm)	ExpressCard	one ExpressCard/54 connector	
сагаз зоррогска	ExpressCard/54 (54 mm)	8-in-1 Media Card Reader	one combo connector	
IEEE 1394/Media Card		Infrared	one RC6 Consumer IR port	
IEEE 1394/Media Card	PCIe-based Ricoh R5U230	Communications		
controller IEEE 1394 interface compliant with standard IEEE 1394a-2000 specification	Network adapter	10/100/1000 Mbps Ethernet LAN on system board		
	specification	Wireless	 WLAN Mini-Card (half Mini-Card slot) WPAN, Bluetooth® card (full Mini-Card slot) 	
Ports and Connectors			- WI AN, DIOCEOGET Card (1011 Filliti Card Stot)	
IEEE 1394 A	one 4-pin serial connector			
Network adapter	one RJ45 connector 10/100/1000 Mbps	Drives Supported		
USB	four 4-pin USB 2.0-compliant connectors	Optical drive	SATA-compliant Blu-ray Disc™ writer, Blu-ray Disc combo, or DVD+/-RW	
eSATA/USB combo	one 11-pin eSATA/USB combo connector	Hard drives	two 2.5-inch drive bays supporting:	
VGA	one 15-hole connector		 SATA-II or SATA-III hard drives 	
DisplayPort	one 20-pin connector		 Solid-state hard drives 	
HDMI	one 19-pin connector			

Media Card Reader		Audio	
Cards supported	Secure Digital (SD) memory cardSecure Digital High Capacity (SDHC) card	Speaker	dual 8-ohms speakers in both the left and right speaker assembly
	Secure Digital Input/Output (SDIO) cardMulti Media Card (MMC)	Internal speaker amplifier	up to 5 W per channel; up to 10 W total power
	Memory Stick	Camera	
	 Memory Stick PRO 	Pixel	2.0 megapixel
,	 xD-Picture Card (type - M and type - H) 	Video resolution	320 x 240 - 1600 x 1200 (640 x 480 at 30 fps)
	Hi Density-SD (SDHD)	Diagonal viewing angle	66°
Video		Keyboard (Backlit)	
Туре	up to two MXM 3.0 Type B compliant cards with total power budget of 150 W	Layouts	U.S. and Canada; Europe; Japan
LCD interface	Low Voltage Differential Signaling (LVDS)	Backlight color	RGB; colors can be changed by invoking the AlienFX® application in the Alienware Command
External display support	VGA, HDMI 1. 2, DisplayPort		Center. For information, see the <i>Mobile Manual</i>
Audio		Display	
Туре	High-Definition 5.1 Surround Sound Audio	Туре	• 17.0 inch, dual-CCFL, WXGA+ (1440 x 900)
Controller II	IDT 92HD73C HDA Codec		 17.0 inch, dual-CCFL, WUXGA (1920 x 1200) 17.0 inch, RGBLED, WUXGA (1920 x 1200)
		Refresh Rate	60 Hz

Display		Battery		
Operating angle Pixel pitch	0° (closed) to 140°	Operating time	operating conditi	g time varies depending on ons and can be significantly rtain power-intensive
WXGA+ WUXGA	0.2550 mm 0.19125 mm	Life span (approximate)	conditions. 300 discharge/ch	·
Controls	brightness can be controlled through keyboard shortcuts	Temperature range		
Taxada a a d		Operating	0° to 50°C (32° to) 122°F)
Touch pad		Storage	−20° to 60°C (−4°	' to 140°F)
X/Y position resolution (graphics table mode)	240 cpi	Coin-cell battery	CR-2032	
Width	71.7-mm (2.8-inches) sensor-active area	AC Adapter		
eight 34.0-mm (1.3-inches) rectangle attery		NOTE: The 150 W AC adapter supports computers with a single graphics card and a non-Extreme Edition processor. Other configurations require the 240 W AC adapter.		
Туре	9-cell "smart" lithium ion (86 Whr)	Туре	240 W	150 W
Height	41.54 mm (1.63 inches)	Input voltage	100-240 VAC	100-240 VAC
Width	292.7 mm (11.52 inches)	Input current	3.5 A	2.1 A
Depth	52.3 mm (2.06 inches)	(maximum)		
Weight	0.52 kg (1.14 lb)	Input frequency	50-60 Hz	50-60 Hz
Voltage				

AC Adapter

<u>'</u>		
Туре	240 W	150 W
Output current (continuous)	12.31 A	7.7 A
Output power	240 W	150 W
Rated output voltage	19.5 VDC	19.5 VDC
Dimensions		
Height	25.4 mm (1.0 inches)	25.4 mm (1.0 inches)
Width	100 mm (3.94 inches)	76.2 mm (3.0 inches)
Depth	200 mm (7.87 inches)	154.7 mm (6.09 inches)
Weight (without AC power cord)	0.85 kg (1.87 lbs)	0.52 kg (1.14 lb)
Temperature range		
Operating	0° to 40°C (32° to 104°F)	0° to 35°C (32° to 95°F)
Storage	–40° to 70°C (–40° to 158°F)	–40° to 70°C (–40° to 158°F)
Connector types		
DC connector	3-pin, 7.4 mm plug	3-pin, 7.4 mm plug
AC connector	3-pin - C13	3-pin - C5

Computer Environment

compoter Environment	
Temperature range:	
Operating	0° to 35°C (32° to 95°F)
Storage	–40° to 65°C (–40° to 149°F)
Relative humidity (maximum):	
Operating	10% to 90% (non-condensing)
Storage	10% to 95% (non-condensing)
Maximum vibration (using a rar environment):	ndom vibration spectrum that simulates user
Operating	0.66 GRMS
Storage	1.3 GRMS
Maximum shock (Measured with half-sine pulse for operating. Als position and a 2-ms halfsine plu	n hard drive in operating status and a 2-ms so measured with hard drive in head-parked use for storage):
Operating	110 G
Storage	160 G
Altitude (maximum):	
Operating	–15.2 to 3048 m (–50 to 10,000 ft)
Storage	-15.2 to 10,668 m (-50 to 35,000 ft)
Airborne contaminant level	G2 or lower as defined by ISA-S71.04-1985